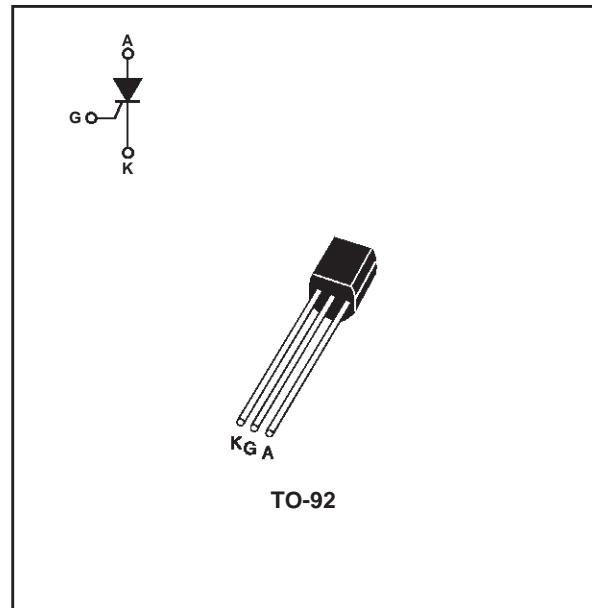


SENSITIVE
0.8A SCRs
MAIN FEATURES:

Symbol	Value	Unit
$I_T(\text{RMS})$	0.8	A
$V_{\text{DRM}}/V_{\text{RRM}}$	100	V
I_{GT}	1	μA

DESCRIPTION

The P0130AA is a gate sensitive SCR, packaged in TO-92, used in conjunction of a TN22 A.S.D.TM and of a resistor in electronic starter for fluorescent tubelamps.


ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
$I_T(\text{RMS})$	RMS on-state current (180° conduction angle)		0.8	A
$I_T(\text{AV})$	Average on-state current (180° conduction angle)		0.5	A
I_{TSM}	Non repetitive surge peak on-state current	$t_p = 8.3 \text{ ms}$	8	A
		$t_p = 10 \text{ ms}$		
I_t	I_t Value for fusing	$t_p = 10\text{ms}$	$T_j = 25^\circ\text{C}$	A^2s
dI/dt	Critical rate of rise of on-state current $I_G = 2 \times I_{\text{GT}}, t_r \leq 100 \text{ ns}$	$F = 60 \text{ Hz}$	$T_j = 125^\circ\text{C}$	$\text{A}/\mu\text{s}$
I_{GM}	Peak gate current	$t_p = 20 \mu\text{s}$	$T_j = 125^\circ\text{C}$	A
$P_{\text{G(AV)}}$	Average gate power dissipation		$T_j = 125^\circ\text{C}$	W
T_{stg} T_j	Storage junction temperature range Operating junction temperature range		- 40 to + 150 - 40 to + 125	$^\circ\text{C}$

P0130AA

ELECTRICAL CHARACTERISTICS ($T_j = 25^\circ\text{C}$, unless otherwise specified)

Symbol	Test Conditions		P0130AA		Unit	
I_{GT}	$V_D = 12 \text{ V}$	$R_L = 140 \Omega$	MIN.	0.1	μA	
V_{GT}			MAX.	1		
V_{GD}	$V_D = V_{DRM} \quad R_L = 3.3 \text{ k}\Omega \quad R_{GK} = 1 \text{ k}\Omega$		$T_j = 125^\circ\text{C}$	MIN.	0.8	
V_{RG}	$I_{RG} = 10 \mu\text{A}$			MIN.	8	
I_H	$I_T = 50 \text{ mA} \quad R_{GK} = 1 \text{ k}\Omega$		MAX.	5	mA	
I_L	$I_G = 1 \text{ mA} \quad R_{GK} = 1 \text{ k}\Omega$		MAX.	6	mA	
dV/dt	$V_D = 67 \% V_{DRM} \quad R_{GK} = 1 \text{ k}\Omega$	$T_j = 125^\circ\text{C}$	MIN.	25	$\text{V}/\mu\text{s}$	
V_{TM}	$I_{TM} = 1.6 \text{ A} \quad t_p = 380 \mu\text{s}$	$T_j = 25^\circ\text{C}$	MAX.	1.95	V	
V_{t0}	Threshold voltage	$T_j = 125^\circ\text{C}$	MAX.	0.95	V	
R_d	Dynamic resistance	$T_j = 125^\circ\text{C}$	MAX.	600	$\text{m}\Omega$	
I_{DRM}	$V_{DRM} = V_{RRM} \quad R_{GK} = 1 \text{ k}\Omega$	$T_j = 25^\circ\text{C}$	MAX.	1	μA	
I_{RRM}		$T_j = 125^\circ\text{C}$	MAX.	100		

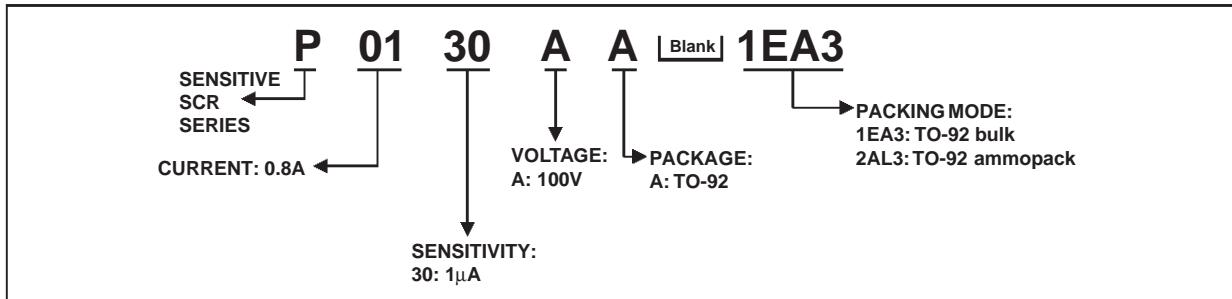
THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-i)}$	Junction to case (DC)	80	$^\circ\text{C}/\text{W}$
$R_{th(j-a)}$	Junction to ambient (DC)	150	$^\circ\text{C}/\text{W}$

PRODUCT SELECTOR

Part Number	Voltage	Sensitivity	Package
P0130AA	100V	1 μA	TO-92

ORDERING INFORMATION



OTHER INFORMATION

Part Number	Marking	Weight	Base Quantity	Packing mode
P0130AA 1EA3	P0130AA	0.2 g	2500	Bulk
P0130AA 2AL3	P0130AA	0.2 g	2000	Ammopack

Note: xx = sensitivity, y = voltage

Fig. 1: Maximum average power dissipation versus average on-state current.

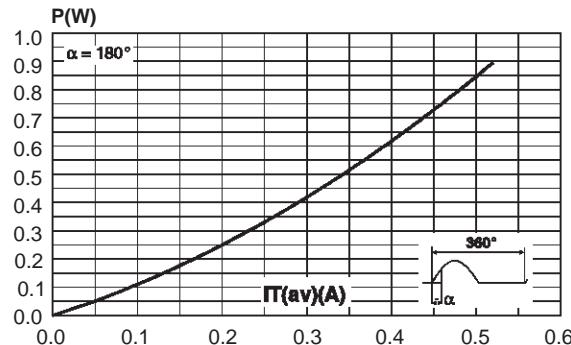


Fig. 2-2: Average and D.C. on-state current versus ambient temperature.

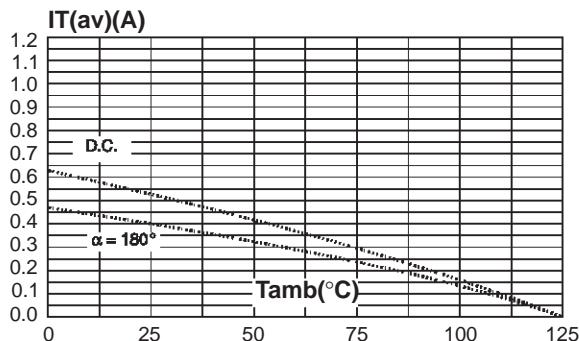


Fig. 2-1: Average and D.C. on-state current versus lead temperature.

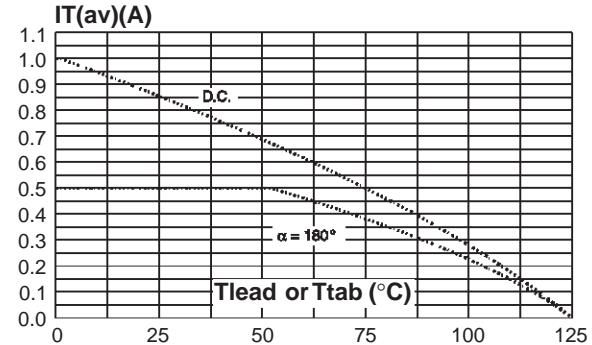


Fig. 3: Relative variation of thermal impedance junction to ambient versus pulse duration.

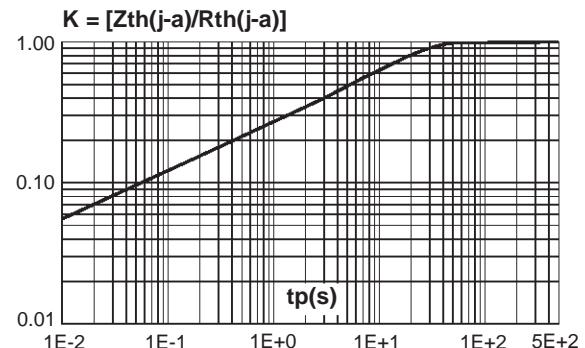


Fig. 4: Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values).

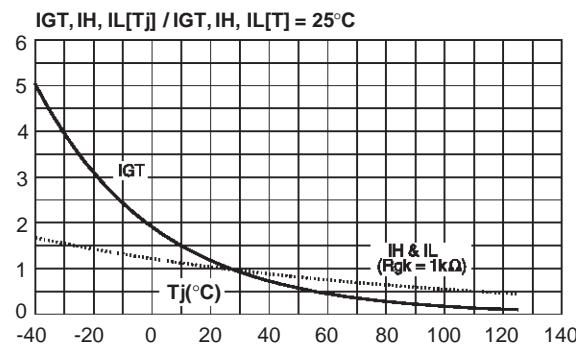


Fig. 6: Relative variation of dV/dt immunity versus gate-cathode resistance (typical values).

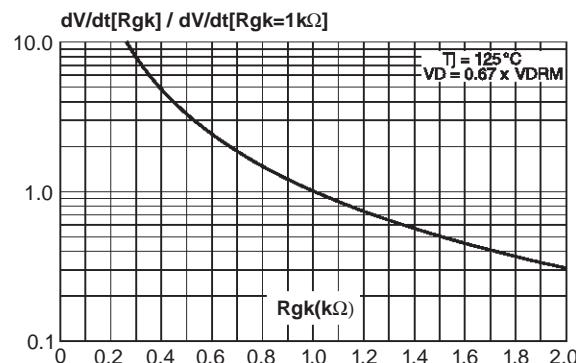


Fig. 8: Surge peak on-state current versus number of cycles.

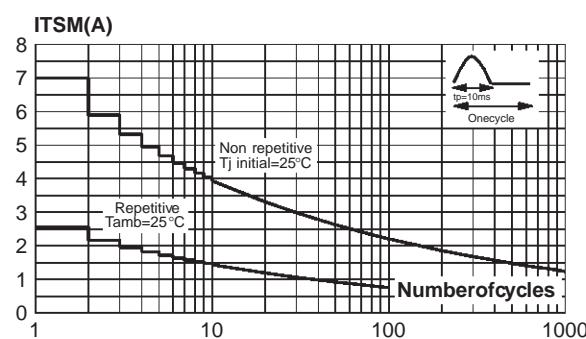


Fig. 5: Relative variation of holding current versus gate-cathode resistance (typical values).

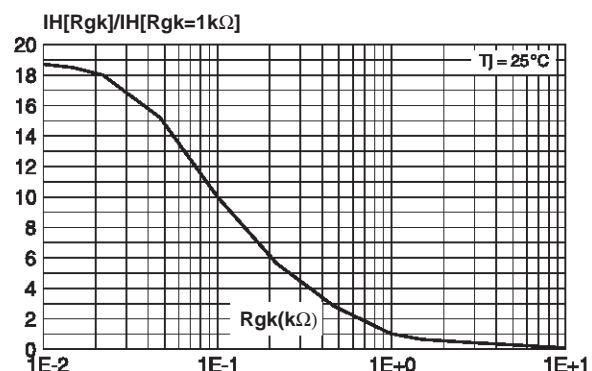


Fig. 7: Relative variation of dV/dt immunity versus gate-cathode capacitance (typical values).

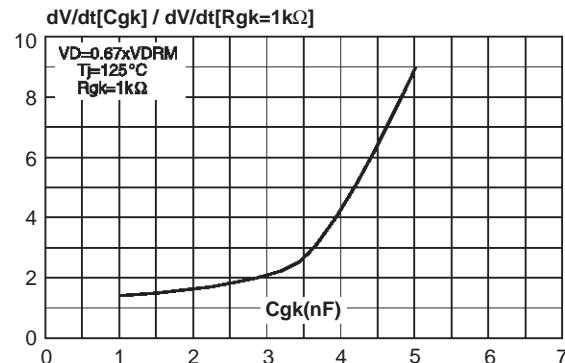


Fig. 9: Non-repetitive surge peak on-state current for a sinusoidal pulse with width tp < 10 ms, and corresponding value of I_t.

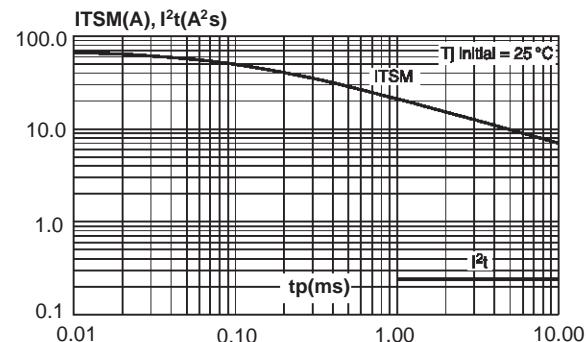
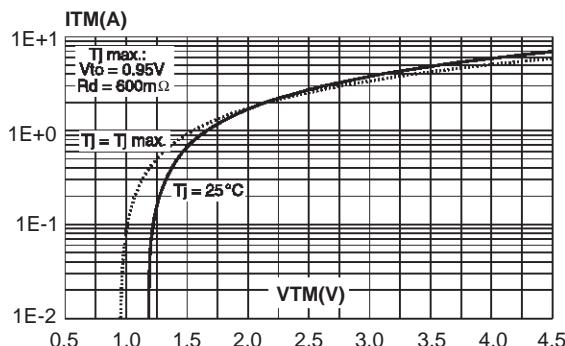


Fig. 10: On-state characteristics (maximum values).



PACKAGE MECHANICAL DATA

TO-92 (Plastic)

REF.	DIMENSIONS					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A		1.35			0.053	
B			4.70			0.185
C		2.54			0.100	
D	4.40			0.173		
E	12.70			0.500		
F			3.70			0.146
a			0.50			0.019

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